# DOINGTER

NH018T2G-L

Description：

This N-Channel MOSFET uses advanced SGT technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.

Features：

1) V_{DS}=100V,I_D=40A,$R_{DS(ON)}$<18mΩ @V_{GS}=10V（Typ： 15mΩ ）

2) Low gate charge.

3) Green device available.

4) Advanced high cell denity SGT technology for ultra low $R_{DS(ON)}$.

5) Excellent package for good heat dissipation.

6) MSL3
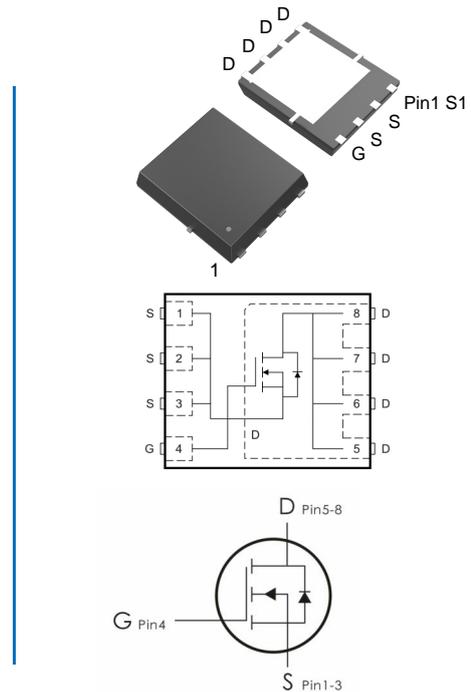
Package Marking and Ordering Information：

Part NO.	Marking	Package	Packing
NH018T2G-L	H018T2-L	DFN5*6-8	5000 pcs/Reel

Absolute Maximum Ratings： (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Continuous Drain Current[1]	40	A
	Continuous Drain Current-T_C=100℃[1]	28	
I_{DM}	Pulsed Drain Current [2]	160	
P_D	Power Dissipation	31	W
E_{AS}	Single pulse avalanche energy [3]	39	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55-+150	℃

Thermal Characteristics：

Symbol	Parameter	Max	Units
$R_{\Theta JC}$	Thermal Resistance,Junction to Case	4	℃/W

Electrical Characteristics： (T_C=25℃ unless otherwise noted)

| Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Sourtce Breakdown Voltage	V_{GS}=0V,I_D=250μA	100	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{GS}=0V, V_{DS}=100V	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0A	---	---	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate-Source Threshold Voltage	V_{GS}=V_{DS}, I_D=250μA	1	1.7	2.5	V
$R_{DS(ON)}$	Drain-Source On Resistance [4]	V_{GS}=10V,I_D=20A	---	15	18	mΩ
		V_{GS}=4.5V,I_D=10A	---	18.5	22	
Dynamic Characteristics						
C_{iss}	Input Capacitance		---	700	---	pF
C_{oss}	Output Capacitance	V_{DS}=50V, V_{GS}=0V, f=1MHz	---	291	--	
C_{rss}	Reverse Transfer Capacitance		---	8	---	
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time		---	4.5	---	ns
t_r	Rise Time	V_{DS}=50V, I_D=5A,	---	5	---	ns
$t_{d(off)}$	Turn-Off Delay Time	R_G=6Ω,V_{GS}=10V	---	16.7	---	ns
t_f	Fall Time		---	8.7	---	ns
Q_g	Total Gate Charge		---	13	---	nC
Q_{gs}	Gate-Source Charge	V_{GS}=10V, V_{DS}=50V, I_D=5A	---	3	---	nC
Q_{gd}	Gate-Drain "Miller" Charge		---	3.5	---	nC
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage	V_{GS}=0V, I_{SD}=20A	---	---	1.2	V
I_S	Continuous Drain Curren	V_D=V_G=0V	---	---	40	A
I_{SM}	Pulsed Drain Current		---	---	160	A
Trr	Reverse Recovery Time	I_F=5A,T_J=25℃	---	39	---	ns
Qrr	Reverse Recovery Charge	dI/dt=100A/us	---	30	---	nC

Notes:

1. Computed continuous current assumes the condition of $T_{j,Max}$ while the actual continuous current depends on the thermal & electro-mechanical application board design
2. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
3. EAS condition : TJ=25℃,VDD=50V,V_G=10V,L=0.5mH
4. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%
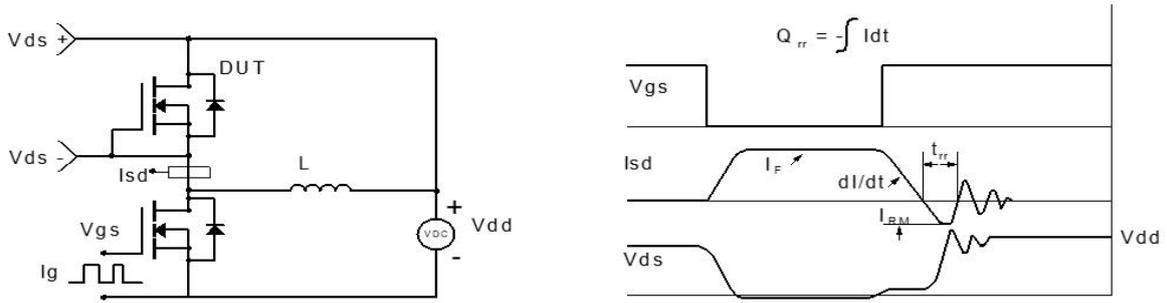
Test Circuit
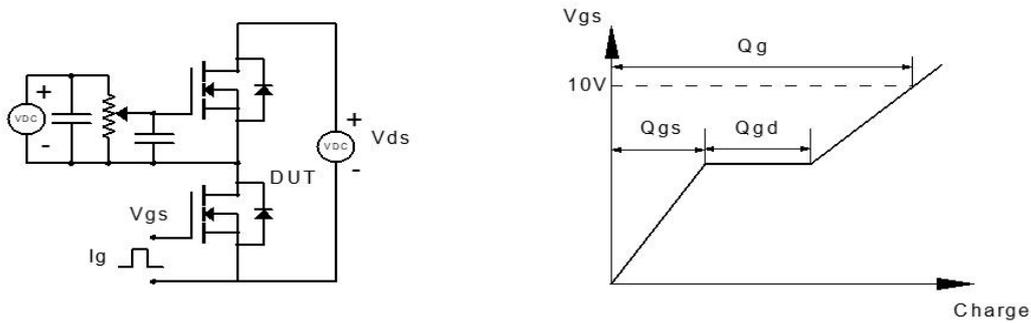
Figure 1: Gate Charge Test Circuit & Waveform
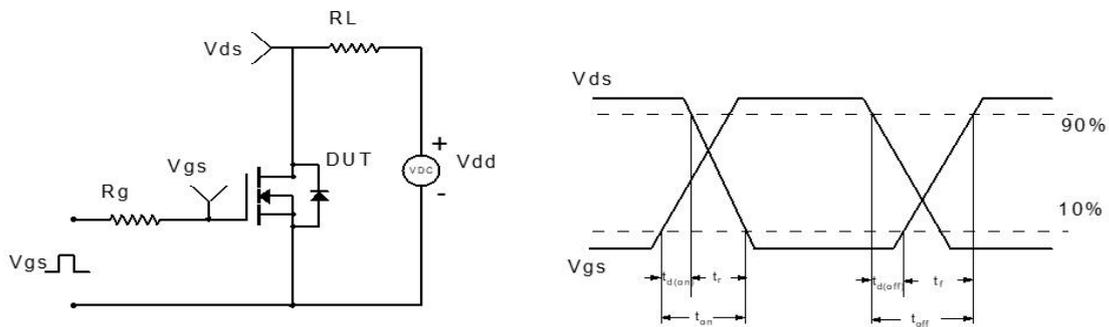
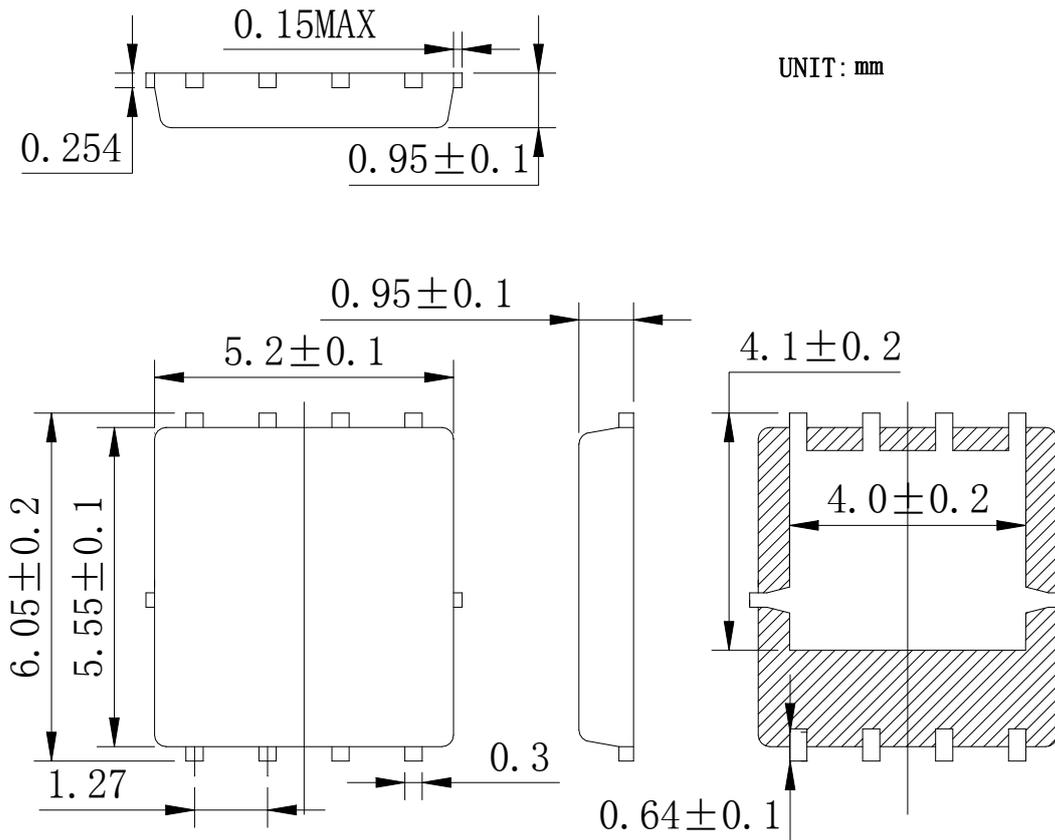**Figure 2: Resistive Switching Test Circuit & Waveform**
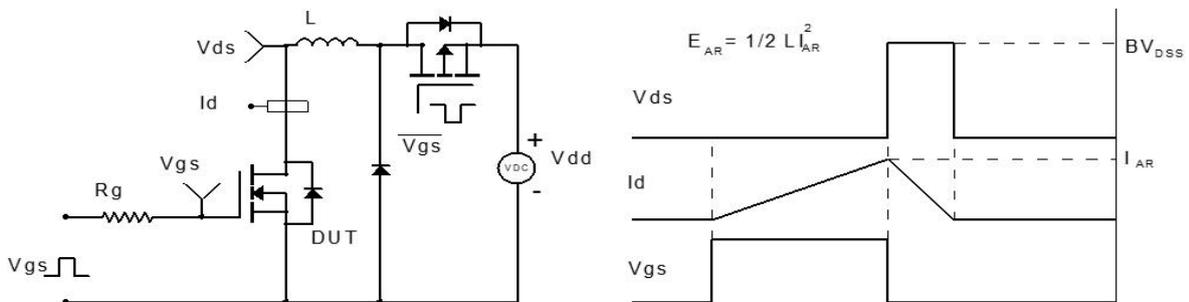
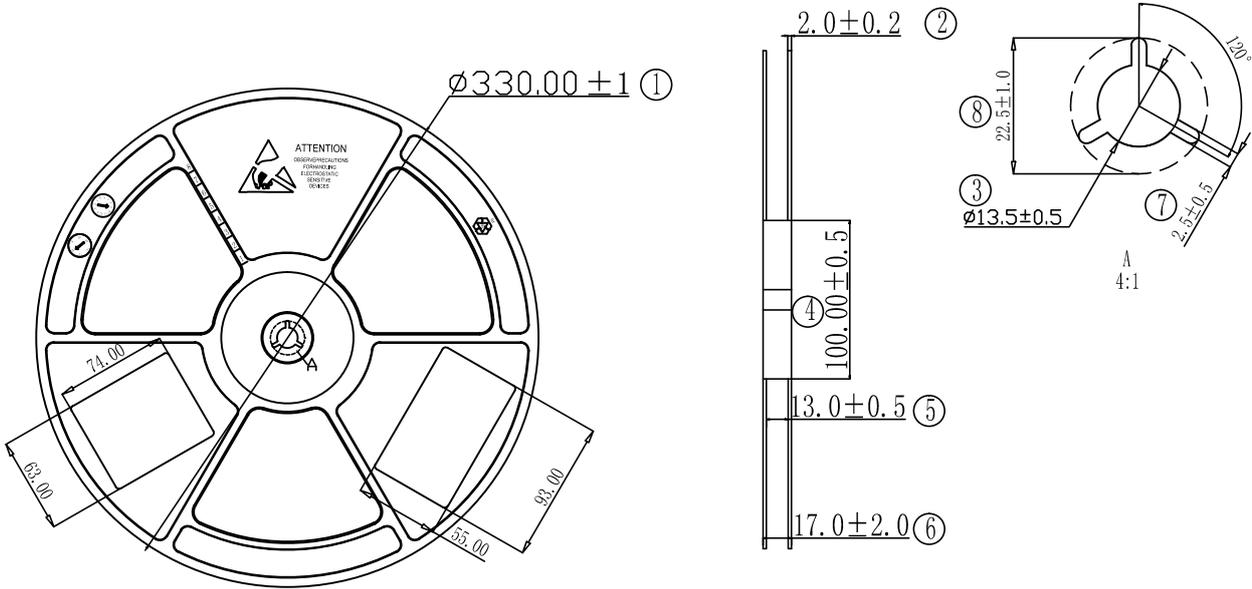**Figure 3: Unclamped Inductive Switching Test Circuit& Waveform**

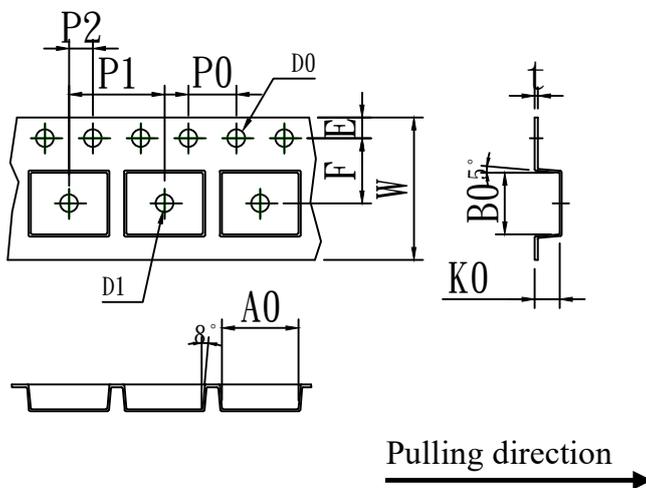**Figure 4: Diode Recovery Test Circuit & Waveform**

DFN5×6-8　Package Information：

UNIT：mm

0.15MAX

0.254

0.95±0.1

0.95±0.1

5.2±0.1

6.05±0.2

5.55±0.1

1.27

0.3

4.1±0.2

4.0±0.2

0.64±0.1

Tape & Reel Information

Dimensions in mm

Symbol	A0	B0	K0	D0	D1	P0	P1	10*P0
Spec	6.15±0.10	5.40±0.10	1.30±0.10	1.55±0.10	1.55±0.10	4.00±0.10	8.00±0.10	40.00±0.10
Symbol	W	E	F	P2	t			
Spec	12.00±0.10	1.75±0.10	5.50±0.10	2.00±0.10	0.20±0.05			

Pulling direction
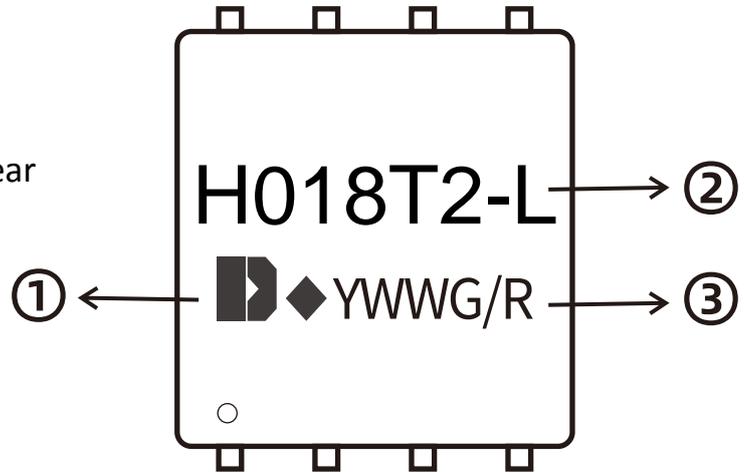
Marking Information：

①. Doingter LOGO

②. Part NO.

③. Date Code(YWWG / R)

    Y : Year Code , last digit of the year

    WW : Week Code(01-53)

    G/R : G(Green) /R(Lead Free)

H018T2-L → ②

◆YWWG/R → ③

① ←

Previous Version

Version	Date	Subjects (major changes since last revision)
1.0	2025-05-06	Release of final version

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